



Product Change Notification

Change Notification #: 119635-00

Change Title: MINOR CHANGE,
Update to Intel Standard Labels & Customer
Custom Specific Labels,
PCN 119635-00, Transport Media, Label,
Adding New Values Country of Fabrication (COF)
and the Final Assembly (COA) to Select Labels Used
in the Shipment of Products

Date of Publication: August 01, 2023

Key Characteristics of the Change:

Transport Media, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	August 11, 2023
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Description of Change to the Customer:

Starting August 11, 2023, Intel will begin implementing a system change that will display the value of the Country of Fabrication (COF) and/or the value of the Country of Final Assembly (COA) on Standard and Customer-specific packaging/box labels which are placed on boxes and used in the shipment & delivery of products to customers.

As a result of adding new values to the labels, the label headers currently referred to and displayed as COO, Assembled In, and Made In (as well as Made In Country X with foreign components) will be replaced with one or both new header names: Manufactured In and Final Assembly.

Next to each of the new label header names being created (i.e. Manufactured In and Final Assembly), the designated value will appear at the right of the header name. The interpretation for the value displayed after Manufactured In will represent the country of fabrication (COF) while the interpretation for the value displayed after Final Assembly will represent the country where Final Assembly (COA) was performed.

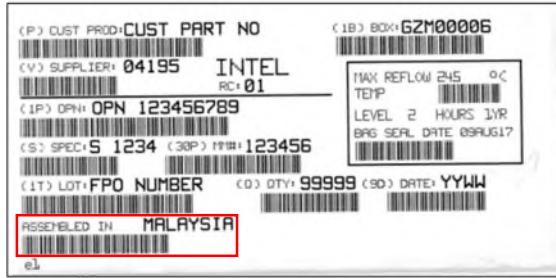
Label Header	Interpretation of Value Displayed
Manufactured In	The country of Fabrication (COF)
Final Assembly	The country of Final Assembly (COA)

Additionally, wherever the name of a country is spelled out on a label today, the updated label value will reflect the common, abbreviated two-digit country code representing the country. If more than one country was involved in the fabrication or final assembly, multiple country code values will appear in the displayed value.

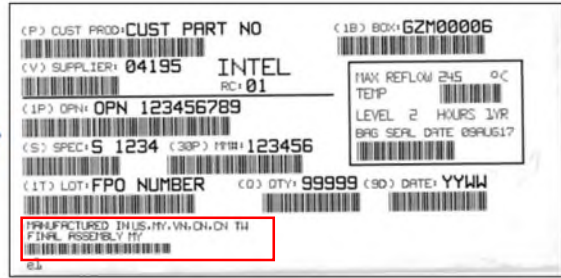
Please be aware that all pictures shared herein are for example purposes only. Each picture represents a change being applied broadly to hundreds of labels and the examples can be adaptive to all possible involved labels without listing every label or possible customization.

Examples of Changes Made to the Standard Intermediate Box

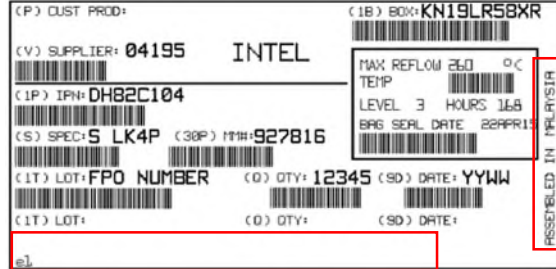
Before



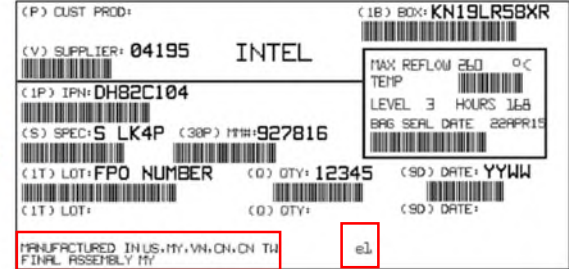
After



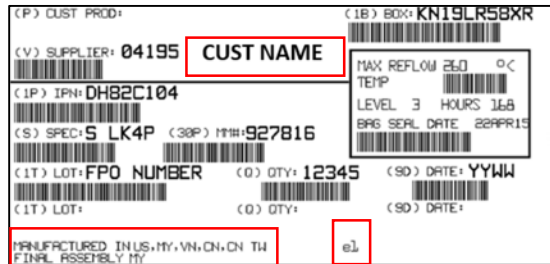
Before



After



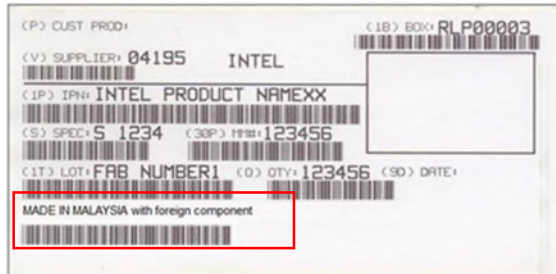
Note: In cases where the Pb-free indicator (i.e., “e1”) is printed on a label, it may shift to the right or print lower on the label, making room to display the Manufactured In (COF) values and/or the Final Assembly (COA) values.



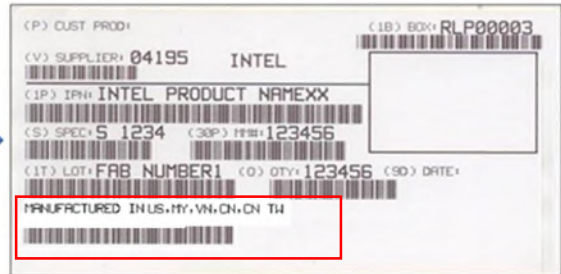
Note: If customers have a unique label showing their customer name in the label, the word “Intel” would be replaced with the customer’s name.

Example of a Standard Die I-Box

Before



After



Note: Made In [Country] with foreign component is replaced by Manufactured In.

Example of a Custom Shipping Label

Before



Label 'Before' details:

- (K) Cust. PO: PO NUMBER
- (P) Cust. Part: CUST PART NO
- (IP) Mfg Part: INTEL PROD NO
- (IK) Packing Slip: DN NUMBER
- (Q) Quantity: 12345
- (SD) Date Code: 1515 (AL) COO: MY
- (L) Lot Code: FPO NUMBER
- (ED) Ship Date: 04/05/15

After



Label 'After' details:

- (K) Cust. PO: PO NUMBER
- (P) Cust. Part: CUST PART NUMBER
- (IP) Mfg Part: INTEL PROD NO
- (IK) Packing Slip: DN NUMBER
- (Q) Quantity: 12345 (SD) Date Code: 1515
- Manufactured in US,MY,VN,CN,CN TW
Final Assembly MY
- (L) Lot Code: FPO NUMBER
- (ED) Ship Date: MM/DD/YYYY

Note: The Date Code field moves, and the COO header is replaced by the header name Manufactured In and Final Assembly Fields.

Customer Impact of Change and Recommended Action:

Intel considers this a Minor Change. This change pertains only to labels used in the shipment of products and not to the actual products themselves. There is no change to the form, fit, functionality, quality or reliability for the products.

This Product Change Notification is being communicated broadly. Not all customers receiving this Product Change Notification will be impacted by this particular label change. The change criteria listed below will determine whether or not a label will be updated as intended.

Scope of Change:

- These label changes are intended only for products categorized by Intel as silicon products or Integrated Circuit (IC) products.
- These changes will only be seen if current labels have any of the headers “COO”, “Assembled In” or “Made In” with their corresponding values printed on the label.
- These changes pertain only to the Standard Intel box labels (i.e. STD Intermediate Box Label, STD Die I-Box Label etc...) as well as Customer-specific labels (i.e. Custom Shipping Label and others), all of which are governed internally by the Mark/Pack/Label Department within Intel. Any similar changes governed by other Intel Business Units outside of the Mark/Pack/Label Department have been or would be communicated via a separate Product Change Notification (PCN).

Customers should expect to see a mixture of shipments using older labels and newly changed labels until the older label stock inventory is fully depleted. Any existing label stock/materials already labeled, packed and stored as warehouse inventory will not be relabeled before shipping to customers.

This change is not expected to be a quick change. The process will start August 11, 2023 and is anticipated to take several quarters to implement across all impacted labels in scope.

Customers should notify your inbound shipment & receiving departments to expect and anticipate these label changes.

Distributors should forward this communication to their customers accordingly.

Please contact your appropriate Intel Account Representative with any questions or concerns regarding the changes communicated in this Product Change Notification.

Products Affected/Intel Ordering Codes:

Please see the attached Excel spreadsheet with the list of affected products.

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 01, 2023	00	Originally Published PCN



Product Change Notification

119635-00

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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

If you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com